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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET



SILICON POWER MOS FET NE5531079A

7.5 V OPERATION SILICON RF POWER LDMOS FET FOR UHF-BAND 10 W TRANSMISSION AMPLIFIERS

DESCRIPTION

The NE5531079A is an N-channel silicon power laterally diffused MOS FET specially designed as the transmission power amplifier for 7.5 V radio systems. Dies are manufactured using our NEWMOS-M1 technology and housed in a surface mount package. This device can deliver 40.0 dBm output power with 68% power added efficiency at 460 MHz under the 7.5 V supply voltage.

FEATURES

High output power : Pout = 40.0 dBm TYP. (VDs = 7.5 V, IDset = 200 mA, f = 460 MHz, Pin = 25 dBm)
 High power added efficiency : ηadd = 68% TYP. (VDs = 7.5 V, IDset = 200 mA, f = 460 MHz, Pin = 25 dBm)
 High linear gain : GL = 20.5 dB TYP. (VDs = 7.5 V, IDset = 200 mA, f = 460 MHz, Pin = 10 dBm)

• Surface mount package : $5.7 \times 5.7 \times 1.1$ mm MAX.

Single supply : VDS = 7.5 V MAX.

APPLICATIONS

460 MHz band radio systems

· 900 MHz band radio systems

ORDERING INFORMATION

| Part Number | Order Number | Package | Marking | Supplying Form |
|----------------|------------------|---------------|---------|---|
| NE5531079A | NE5531079A-A | 79A (Pb-Free) | W5 | 12 mm wide embossed taping Gate pin face the perforation side of the tape |
| NE5531079A-T1 | NE5531079A-T1-A | | | 12 mm wide embossed taping Gate pin face the perforation side of the tape Qty 1 kpcs/reel |
| NE5531079A-T1A | NE5531079A-T1A-A | | | 12 mm wide embossed taping Gate pin face the perforation side of the tape Qty 5 kpcs/reel |

Remark To order evaluation samples, please contact your nearby sales office.

Part number for sample order: NE5531079A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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ABSOLUTE MAXIMUM RATINGS (Ta = +25°C)
Operation in excess of any one of these parameters may result in permanent damage.

| Parameter | Symbol | Ratings | Unit |
|----------------------------|------------------------|-------------|------|
| Drain to Source Voltage | V _{DS} Note 1 | 30 | ٧ |
| Gate to Source Voltage | V _{GS} | 6.0 | ٧ |
| Drain Current | Ips | 3.0 | Α |
| Drain Current (Pulse Test) | IDS Note 2 | 6.0 | Α |
| Total Power Dissipation | Ptot | 35 | W |
| Channel Temperature | Tch | 125 | °C |
| Storage Temperature | T _{stg} | -55 to +125 | °C |

Note 1. V_{DS} will be used under 12 V on RF operation.

2. Duty Cycle \leq 50%, Ton \leq 1 s

RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|-------------------------|-----------------|--------------------------|------|------|------|------|
| Drain to Source Voltage | V _{DS} | | - | 6.0 | 7.5 | ٧ |
| Gate to Source Voltage | V _{GS} | | 1.15 | 1.55 | 2.05 | ٧ |
| Drain Current | los | | _ | 2.0 | - | Α |
| Input Power | Pin | f = 460 MHz, Vps = 6.0 V | - | 25 | 30 | dBm |

ELECTRICAL CHARACTERISTICS

(TA = +25°C, unless otherwise specified, using our standard test fixture)

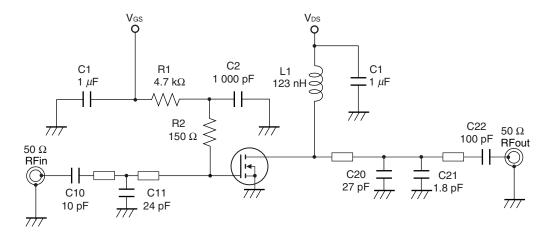
| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|---|--------------------|---|------|------|------|------|
| Gate to Source Leakage Current | Igss | V _{GS} = 6.0 V | _ | _ | 100 | nA |
| Drain to Source Leakage Current (Zero Gate Voltage Drain Current) | loss | V _{DS} = 25 V | - | - | 10 | nA |
| Gate Threshold Voltage | V _{th} | V _{DS} = 7.5 V, I _{DS} = 1.0 mA | 0.8 | 1.15 | 1.55 | ٧ |
| Thermal Resistance | Rth | Channel to Case | _ | 2.9 | - | °C/W |
| Transconductance | g _m | V _{DS} = 7.5 V, I _{DS} = 700±100 mA | 2.5 | 3.2 | 4.0 | S |
| Drain to Source Breakdown Voltage | BVDSS | $loss = 10 \mu A$ | 25 | 35 | - | ٧ |
| Output Power | Pout | f = 460 MHz, V _{DS} = 7.5 V, | 39.0 | 40.0 | - | dBm |
| Drain Current | los | P _{in} = 25 dBm, | - | 2.0 | - | Α |
| Power Added Efficiency | $\eta_{ m add}$ | I _{Dset} = 200 mA (RF OFF) | _ | 68 | _ | % |
| Linear Gain | GL ^{Note} | | _ | 20.5 | _ | dB |

Note Pin = 10 dBm

DC performance is 100% testing. RF performance is testing several samples per wafer.

Wafer rejection criteria for standard devices is 1 reject for several samples.

TEST CIRCUIT (f = 460 MHz)

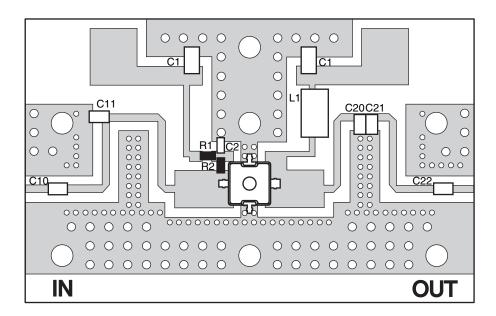


The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

COMPONENTS OF TEST CIRCUIT FOR MEASURING ELECTRICAL CHARACTERISTICS

| Symbol | Value | Туре | Maker |
|--------|--------------|---|-----------------------------|
| C1 | 1 <i>μ</i> F | GRM31CR72A105KA01B | Murata |
| C2 | 1 000 pF | GRM1882C1H102JA01 | Murata |
| C10 | 10 pF | GRM1882C1H100JA01 | Murata |
| C11 | 24 pF | ATC100A240JW | American Technical Ceramics |
| C20 | 27 pF | ATC100A270JW | American Technical Ceramics |
| C21 | 1.8 pF | ATC100A1R8BW | American Technical Ceramics |
| C22 | 100 pF | ATC100A101JW | American Technical Ceramics |
| R1 | 4.7 kΩ | 1/8W Chip Resistor | - |
| R2 | 150 Ω | 1/8W Chip Resistor | - |
| L1 | 123 nH | ϕ 0.5 mm, ϕ D = 3 mm, 10 Turns | Ohesangyou |
| РСВ | _ | R4775, t = 0.4 mm, ε r = 4.5, size = 30 × 48 mm | - |

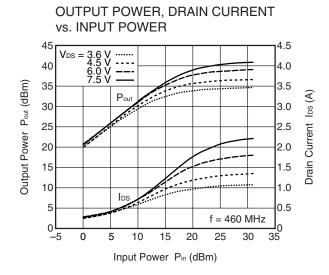
ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

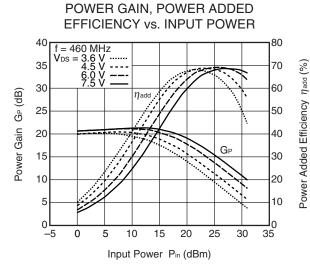


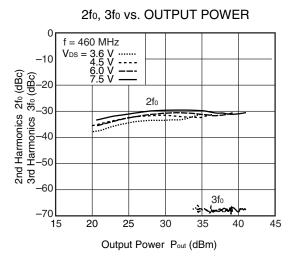
USING THE NEC EVALUATION BOARD

| Symbol | Value |
|--------|--------------|
| C1 | 1 <i>μ</i> F |
| C2 | 1 000 pF |
| C10 | 10 pF |
| C11 | 24 pF |
| C20 | 27 pF |
| C21 | 1.8 pF |
| C22 | 100 pF |
| R1 | 4.7 kΩ |
| R2 | 150 Ω |
| L1 | 123 nH |

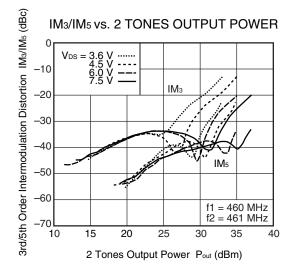
TYPICAL CHARACTERISTICS (TA = +25°C, IDset = 200 mA, unless otherwise specified)







Remark The graphs indicate nominal characteristics.



NEC NE5531079A

S-PARAMETERS

S-parameters and noise parameters are provided on our Web site in a format (S2P) that enables the direct import of the parameters to microwave circuit simulators without the need for keyboard inputs.

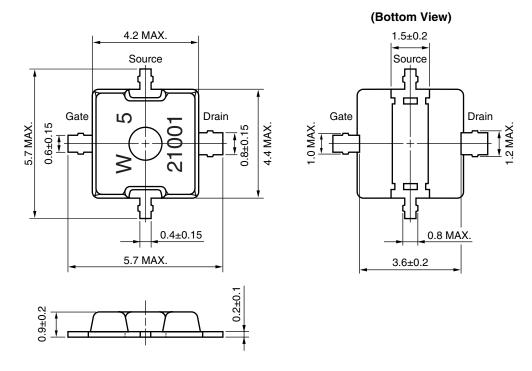
Click here to download S-parameters.

 $[\mathsf{RF} \ \mathsf{and} \ \mathsf{Microwave}] \to [\mathsf{Device} \ \mathsf{Parameters}]$

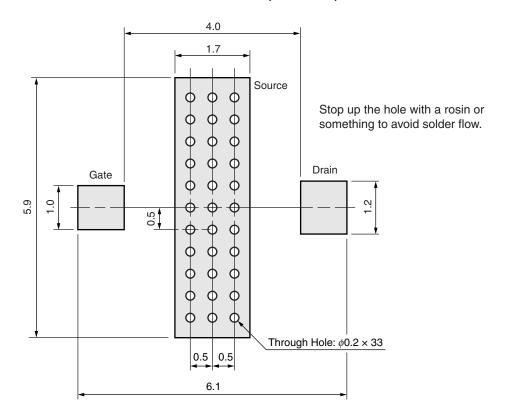
URL http://www.necel.com/microwave/en/

PACKAGE DIMENSIONS

79A (UNIT: mm)



79A PACKAGE RECOMMENDED P.C.B. LAYOUT (UNIT: mm)





RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions | Condition Symbol | |
|------------------|---|---|----------|
| Infrared Reflow | Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass) | : 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below | IR260 |
| Wave Soldering | Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass) | : 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below | WS260 |
| Partial Heating | Peak temperature (pin temperature) Soldering time (per pin of device) Maximum chlorine content of rosin flux (% mass) | : 350°C or below : 3 seconds or less : 0.2%(Wt.) or below | HS350-P3 |

Caution Do not use different soldering methods together (except for partial heating).

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